

MOSFET

OptiMOS[™]5 Power-Transistor, 80 V

Features

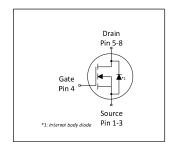
- Ideal for high frequency switching and sync. rec.
 Optimized technology for DC/DC converters
 Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}

- Very low on-resistance RDS(on)
 N-channel, logic level
 100% avalanche tested
 Pb-free plating; RoHS compliant
 Qualified according to JEDEC¹⁾ for target applications
 Halogen-free according to IEC61249-2-21
- Higher solder joint reliability with enlarged source interconnection

Table 1 **Key Performance Parameters**

- and							
Parameter	Value	Unit					
V _{DS}	80	V					
R _{DS(on),max}	7.0	m $Ω$					
I _D	74	A					
Qoss	29	nC					
Q _G (0V4.5V)	14	nC					











Type / Ordering Code	Package	Marking	Related Links
BSZ070N08LS5	PG-TSDSON-8 FL	070N08L	-



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

B	C I I	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	-	74 47 13	А	T _C =25 °C T _C =100 °C T _A =25 °C, R _{thJA} =60 K/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	296	Α	T _C =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	104	mJ	I_D =20 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	69	W	T _C =25 °C
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	_	1.1	1.8	K/W	-
Device on PCB, minimal footprint	R _{thJA}	-	-	62	K/W	-
Device on PCB, 6 cm ² cooling area ²⁾	R_{thJA}	-	-	60	K/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed in as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Paramatan.	0		Values		1114	N	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	80	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	1.1	1.7	2.3	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=36\ \mu {\rm A}$	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =80 V, V _{GS} =0 V, T _j =25 °C V _{DS} =80 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	1	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	7.4 5.9	9.4 7.0	mΩ	V _{GS} =4.5 V, I _D =10 A V _{GS} =10 V, I _D =20 A	
Gate resistance ¹⁾	R _G	-	1.3	2	Ω	-	
Transconductance	g_{fs}	26	52	-	S	$ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 20 A$	

 Table 5
 Dynamic characteristics

Davamatar	Symbol	Values			l loit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	C _{iss}	-	1800	2340	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	280	364	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	12	21	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	6.1	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω
Rise time	t _r	-	4.8	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω
Turn-off delay time	$t_{ m d(off)}$	-	24.6	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω
Fall time	t _f	-	5.8	-	ns	V_{DD} =40 V, V_{GS} =10 V, I_{D} =20 A, $R_{\text{G,ext}}$ =3 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Cumbal	Values			11	Note / Took Open differen
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	5	-	nC	V_{DD} =40 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate to drain charge ¹⁾	Q_{gd}	-	5	7	nC	V_{DD} =40 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Switching charge	Q _{sw}	-	6.9	-	nC	V_{DD} =40 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	14.1	18	nC	V_{DD} =40 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.9	-	V	V_{DD} =40 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate charge total, sync. FET	Q _{g(sync)}	-	25	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Q _{oss}	-	29	39	nC	V _{DD} =40 V, V _{GS} =0 V

Defined by design. Not subject to production test See "Gate charge waveforms" for parameter definition



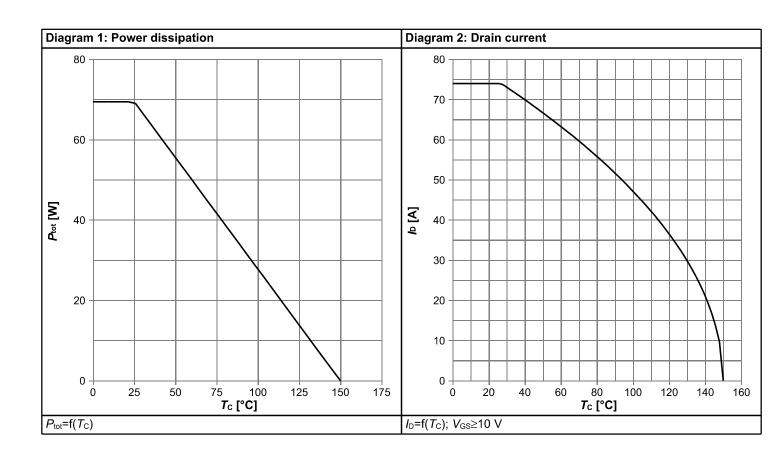
Table 7 Reverse diode

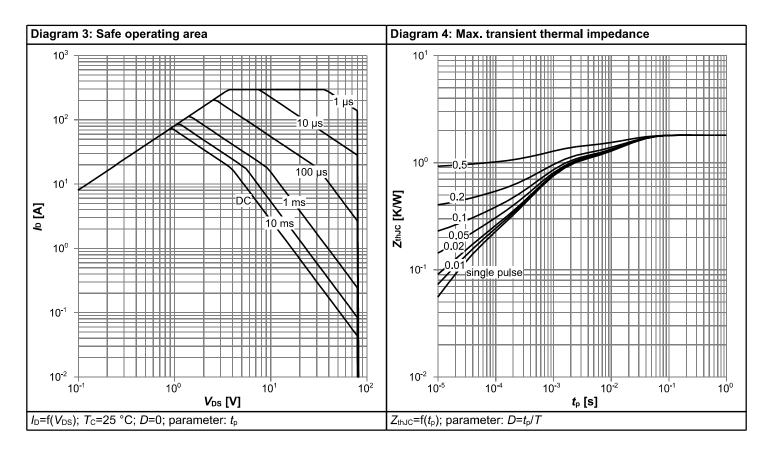
Parameter	Comple al		Values			No. 1. T. of O. of Physics
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continous forward current	Is	-	-	48	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	296	Α	T _C =25 °C
Diode forward voltage	$V_{ ext{SD}}$	-	0.85	1.2	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	32	64	ns	V _R =40 V, I _F =20 A, d <i>i</i> _F /d <i>t</i> =100 A/μs
Reverse recovery charge ¹⁾	Q _{rr}	-	27	54	nC	V _R =40 V, I _F =20 A, d <i>i</i> _F /d <i>t</i> =100 A/μs

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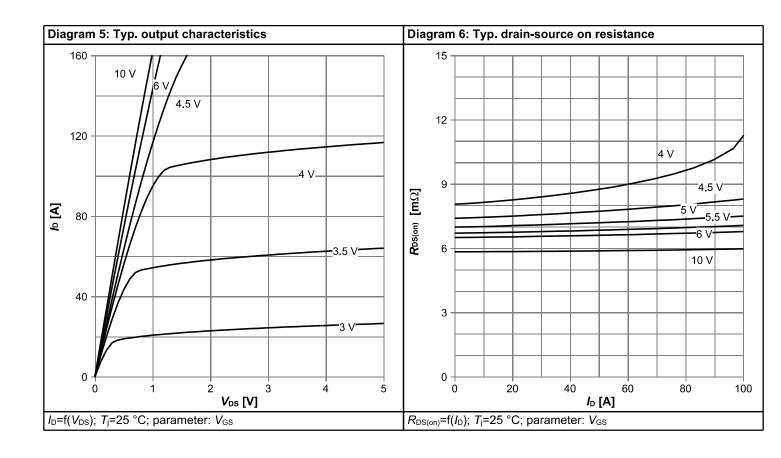


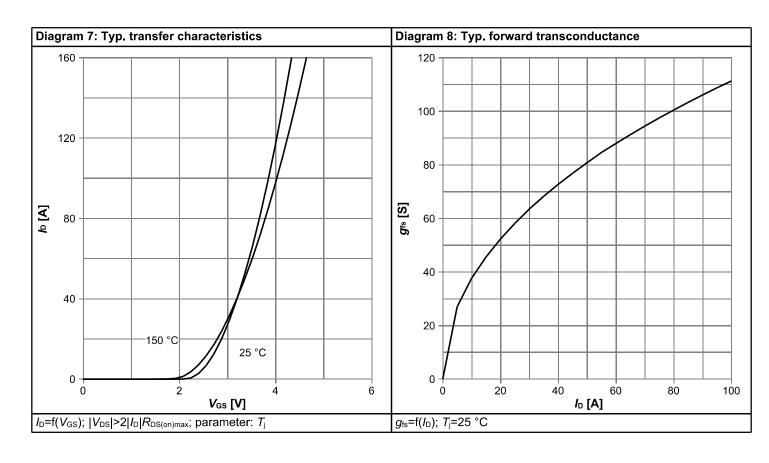
4 Electrical characteristics diagrams



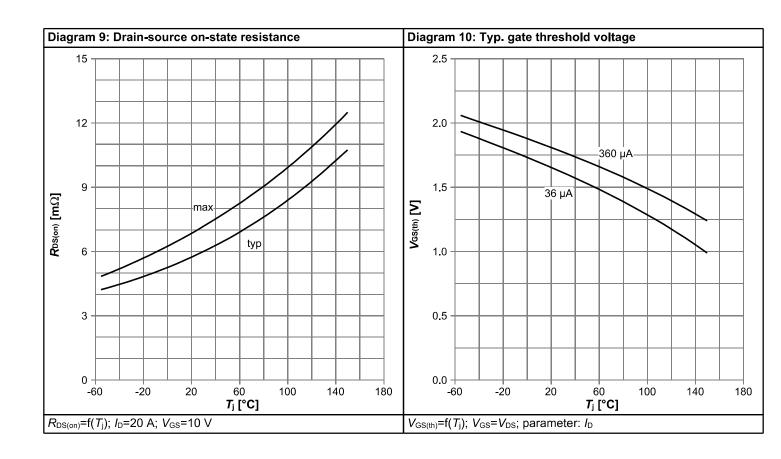


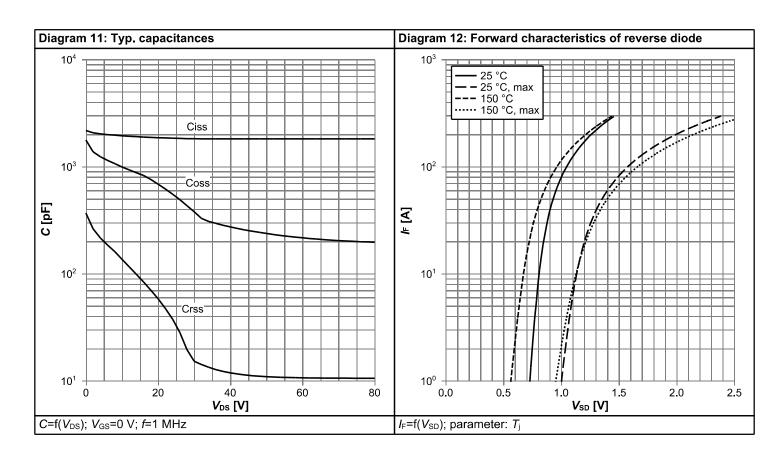




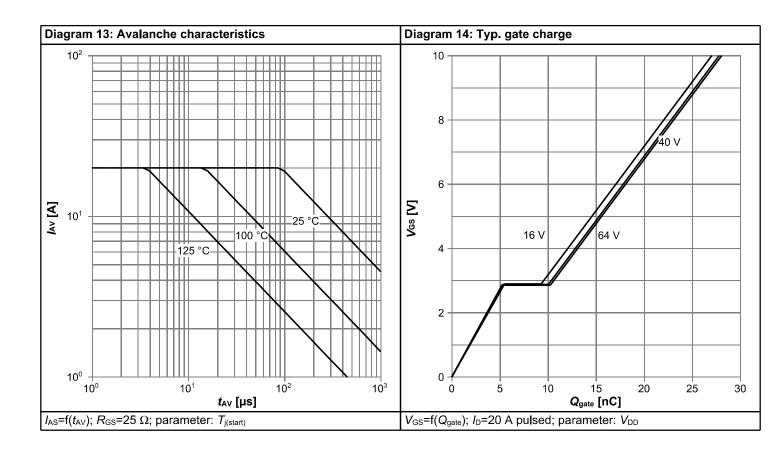


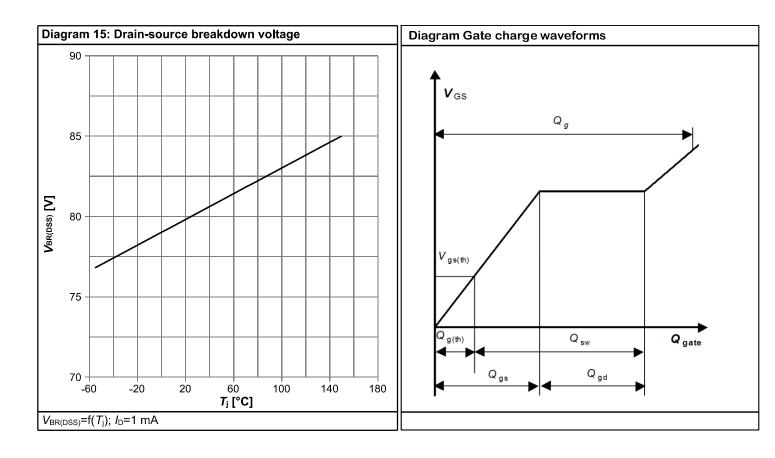






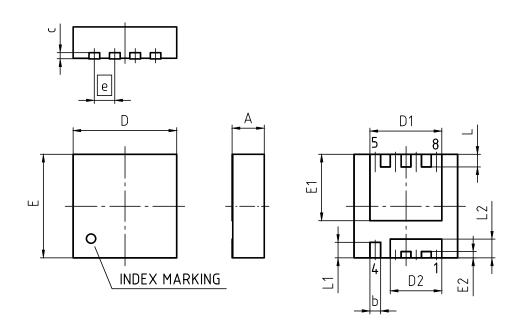








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-TSDS	PG-TSDSON-8-U03				
REVISION: 03	DATE:	20.10.2020				
DIMENSIONS	MILLIM	ETERS				
DIMENSIONS	MIN.	MAX.				
Α	0.90	1.10				
b	0.24	0.44				
С	(0.	20)				
D	3.20	3.40				
D1	2.19	2.39				
D2	1.54	1.74				
E	3.20	3.40				
E1	2.01	2.21				
E2	0.10	0.30				
е	0.65					
L	0.30	0.50				
L1	0.40	0.60				
L2	0.50	0.70				
aaa	0.0)6				

Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm



Revision History

BSZ070N08LS5

Revision: 2021-04-16, Rev. 2.3

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2016-03-23	Release of final version
2.1	2016-04-21	Update "Gate threshold voltage"
2.2	2016-08-18	Update Qsw
2.3	2021-04-16	Update current rating and package drawing

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